



TEC-BOND 7731F/BK HOTMELT ADHESIVE

**POWER
ADHESIVES**

DATA SHEET

GENERAL DESCRIPTION

TEC-BOND 7731F has been developed for case sealing and is ideal for a wide range of applications where a fast speed of set is required. It has a versatile level of adhesion and retains bond integrity at high and low ambient temperatures.

This adhesive can also be used for microwaveable packaging. We would recommend careful evaluation due to the variations in pack designs, contents and cook times.

TECHNICAL CHARACTERISTICS

Adhesive type:	Synthetic polymer based hotmelt
Colour:	Pearl
Molten tack:	High
Brookfield viscosity (ASTM D3236) @ 180°C spindle 27	1175 CPS @ 160°C (320 °F) Typical value
Ring & Ball softening point (ASTM E28):	110°C (230° F) Typical value
Open Time:	Short

SUGGESTED APPLICATION TEMPERATURE

Suggested running temperature 140 -160°C (285-320°F) depending upon materials to be bonded.

PACKAGING

Physical form: Pastilles

F.D.A approved. All the constituent parts of this adhesive have been approved by the American F.D.A under C.F.R 21.175.105 (Adhesives).

HEALTH & SAFETY

Please refer to Power Adhesives Health & safety data sheet.

The information contained on this data sheet is for guidance only. It is the result of careful laboratory evaluations by trained and qualified staff using British Standard or similar test methods. However, no warranty is expressed or implied regarding the accuracy of this data or the suitability of the adhesive for any specific purpose. In every case we strongly recommend that the user shall make their own tests to determine to their own satisfaction the suitability of the adhesive for their particular purpose. Neither seller or manufacturer shall be liable for any injury, loss, damage. Direct or consequential arising out of the use or inability to use the product.

HEALTH & SAFETY

Hotmelt adhesives pose virtually no hazards to health when used in normal industrial practice, but because they are used in a molten state at high temperatures there is a risk of thermal burns. Skin contact with molten hotmelt should be avoided and precautions taken against accidental splashes of adhesive. The use of overalls, cotton gloves and safety glasses help minimise the risk of burns.

INHALATION: Vapours given off during normal operation are not considered toxic, but if overheated, chemical breakdown of the components may occur releasing a complex mixture of organic materials, some of which may be toxic or irritant. Ensure hotmelts are run at the recommended operating temperatures and use in a well-ventilated area.

EYE CONTACT: For solid hotmelt treat as inert particles and irrigate copiously with clean fresh water. For molten hotmelt irrigate with cold water and seek medical advice immediately.

SKIN CONTACT: Solid cold hotmelt is harmless to the skin. Wash hands with soap and water. Skin affected by molten hotmelt should be plunged into cold water immediately and left until the burning sensation subsides. If no tap is accessible have a bucket of clean cold water available. If coated with hotmelt move fingers to prevent a tourniquet effect as it cools. Do not remove the adhesive when molten as it might remove skin to quite a depth leaving a raw wound. Even when solid remove with care as the above may still occur. If difficult to remove, with medical approval, olive oil or liquid paraffin should be soaked into a cotton wool pad and placed over the affected area. This will slowly soften the adhesive into the pad. When hotmelt is removed treat as a normal burn.

FIRE: Not normally a hazard, but in a fire hotmelts are combustible, use dry powder or CO2 extinguisher. Do not use water.

STORAGE Store in a clean dry place at temperatures between 5°C (40°F) and 30°C (85°F) with boxes closed. Do not expose to direct sunlight or localised heat sources such as radiators or hot pipes.

REMOVAL OF GLUE Assembled components can be separated by heating assembly to a temperature slightly above the heat resistance figure.

EVA & POLYPROPYLENE: Residues of EVA and polypropylene based hotmelts can be removed from components with white spirit.

POLYAMIDE: Residues of Polyamide based hotmelt can be removed from components with acetone.

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